

MAX32664

Ultra-Low Power Biometric Sensor Hub

General Description

The MAX32664 is a sensor hub family with embedded firmware and algorithms for wearables. It seamlessly enables customer-desired sensor functionality, including communication with Maxim's optical sensor solutions and delivering raw or calculated data to the outside world. This is achieved while keeping overall system power consumption in check.

The MAX32664 Version A supports the MAX30101/MAX30102 high-sensitivity pulse oximeter and heart rate sensor for wearable health for finger-based applications.

The MAX32664 Version B supports the MAX86140/MAX86141 for wrist-based monitoring.

The sensor hub interface provides a fast-mode, I²C slave interface to a microcontroller host. A second I²C interface is dedicated to communicating with sensors.

The tiny form factor (1.6mm x 1.6mm, 16-bump WLP) allows for integration into extremely small application devices.

Applications

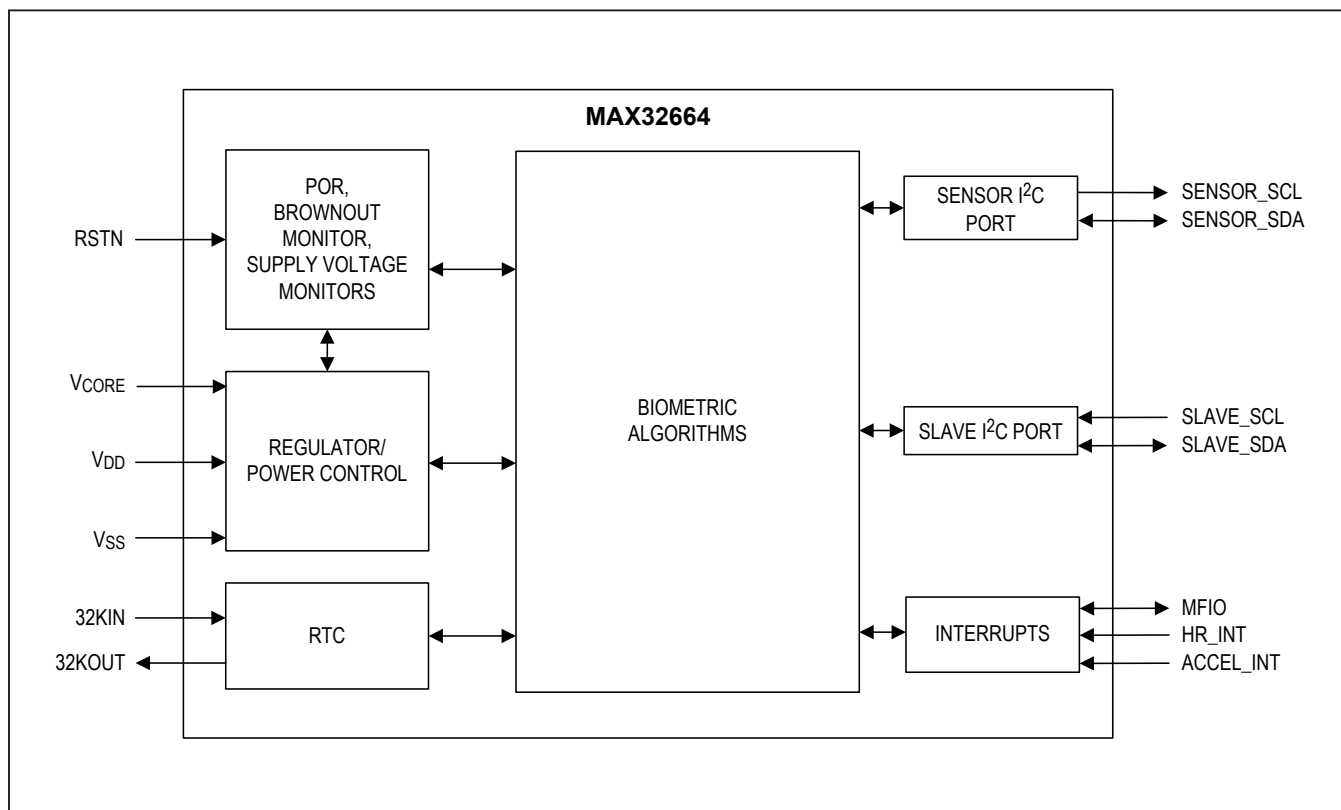
- Wearable Fitness
- Hearables
- Wearable Medical
- Portable Medical
- Mobile Devices

Benefits and Features

- Biometric Sensor Hub Solution Enables Faster Time to Market
- Finger-Based (Version A) Algorithms Measure
 - Pulse Heart Rate
 - Pulse Blood Oxygen Saturation (SpO₂)
- Both Raw and Processed Data Are Available
- Basic Peripheral Mix Optimizes Size and Performance
 - One Slave I²C for Communication to a Host Microcontroller
 - One Master I²C for Communication with Sensors
 - 32.768kHz RTC
 - FIFO Provides Minimal Host Processor Interaction
 - Secure, Authenticated Firmware Upgrades

Ordering Information appears at end of data sheet.

Simplified Block Diagram



Absolute Maximum Ratings

(All voltages with respect to V_{SS} , unless otherwise noted.)

V_{CORE}	-0.3V to +1.21V
V_{DD}	-0.3V to +3.63V
32KIN, 32KOUT.....	-0.3V to $V_{DD} + 0.3V$
RSTN.....	-0.3V to $V_{DD} + 0.3V$
Total Current into All Digital Pins Combined (sink)	100mA
V_{SS}	100mA

Output Current (sink) by Any Digital Pin	25mA
Output Current (source) by Any Digital Pin	-25mA
Operating Temperature Range	-40°C to +105°C
Storage Temperature Range	-65°C to +150°C
Soldering Temperature (reflow)	+260°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Package Information

16 WLP

Package Code	W161K1+1
Outline Number	21-100241
Land Pattern Number	Refer to Application Note 1891
Thermal Resistance, Four-Layer Board:	
Junction to Ambient (θ_{JA})	66.34 °C/W
Junction to Case (θ_{JC})	N/A

For the latest package outline information and land patterns (footprints), go to www.maximintegrated.com/packages. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to www.maximintegrated.com/thermal-tutorial.

Electrical Characteristics

(Limits are 100% tested at $T_A = +25^{\circ}\text{C}$ and $T_A = +105^{\circ}\text{C}$. Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Specifications marked GBD are guaranteed by design and not production tested. Specifications to the minimum operating temperature are guaranteed by design and are not production tested.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
POWER SUPPLIES						
Supply Voltage	V_{DD}		1.71	1.8	3.63	V
Power-Fail Reset Voltage	V_{RST}	Monitors V_{DD}	1.63		1.71	V
Power-On Reset Voltage	V_{POR}	Monitors V_{DD}		1.4		V
DIGITAL I/O						
Input Low Voltage for RSTN, SLAVE_SCL	V_{IL_RSTN}				$0.3 \times V_{DD}$	V
Input High Voltage for All GPIO, RSTN	V_{IH_RSTN}		$0.7 \times V_{DD}$			V
Output Low Voltage for SENSOR_SDA, SENSOR_SCL, SLAVE_SDA	V_{OL_I2C}	$V_{DD} = 1.71\text{V}$, $I_{OL} = 2\text{mA}$		0.2	0.4	V
Output High Voltage for SENSOR_SDA, SENSOR_SCL, SLAVE_SDA	V_{OH_I2C}	$V_{DD} = 1.71\text{V}$, $I_{OH} = 2\text{mA}$,	$V_{DD} - 0.4$			V
Input Hysteresis (Schmitt)	V_{IHYS}			300		mV
Input/Output Pin Capacitance for All Pins	C_{IO}			4		pF
Input Leakage Current Low	I_{IL}	$V_{IN} = 0\text{V}$, internal pullup disabled	-500		+500	nA
Input Leakage Current High	I_{IH}	$V_{IN} = 3.6\text{V}$, internal pulldown disabled	-500		+500	nA
Input Pullup Resistor to RSTN	R_{PU_VDD}	Pullup to $V_{DD} = 3.63\text{V}$		10.5		k Ω
CLOCKS						
System Clock Frequency	f_{SYS_CLK}			96		MHz
RTC Input Frequency	f_{32KIN}	32.768kHz watch crystal, $C_L = 6\text{pF}$, $ESR < 90\text{k}\Omega$, $C_0 < 2\text{pF}$		32.768		kHz
RTC Operating Current	I_{RTC}	All power modes, RTC enabled		0.57		μA
RTC Power-Up Time	t_{RTC_ON}			250		ms

Electrical Characteristics—I²C

(Limits are 100% tested at T_A = +25°C and T_A = +105°C. Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Specifications marked GBD are guaranteed by design and not production tested. Specifications to the minimum operating temperature are guaranteed by design and are not production tested.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
FAST MODE						
Output Fall Time	t _{OF}	From V _{OL_I2C} (MIN) to V _{OL_I2C} (MAX)		150		ns
Pulse Width Suppressed by Input Filter	t _{SP}			75		ns
SCL Clock Frequency	f _{SCL}		0		400	kHz
Low Period SCL Clock	t _{LOW}		1.3			μs
High Time SCL Clock	t _{HIGH}		0.6			μs
Setup Time for Repeated Start Condition	t _{SU;STA}		0.6			μs
Hold Time for Repeated Start Condition	t _{HD;STA}		0.6			μs
Data Setup Time	t _{SU;DAT}			125		ns
Data Hold Time	t _{HD;DAT}			10		ns
Rise Time for SDA and SCL	t _R			30		ns
Fall Time for SDA and SCL	t _F			30		ns
Setup Time for a Stop Condition	t _{SU;STO}		0.6			μs
Bus Free Time Between a Stop and Start Condition	t _{BUS}		1.3			μs
Data Valid Time	t _{VD;DAT}		0.9			μs
Data Valid Acknowledge Time	t _{VD;ACK}		0.9			μs

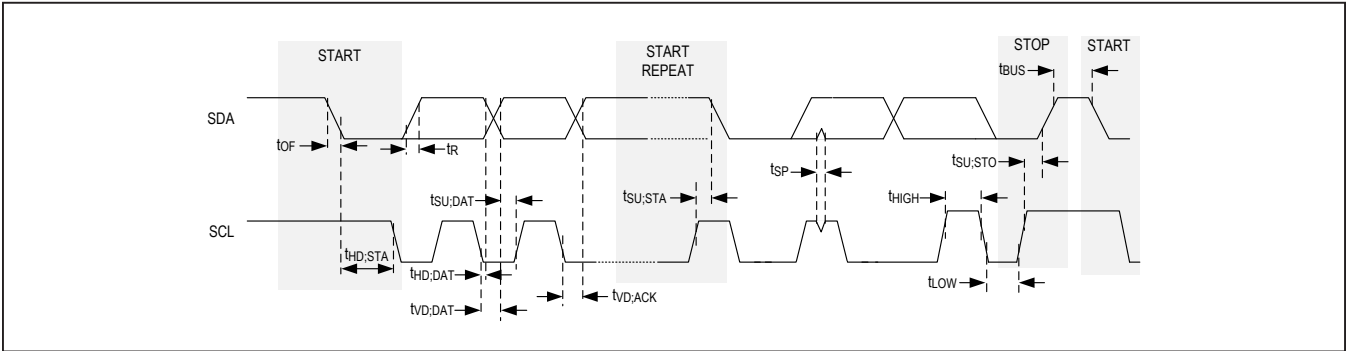
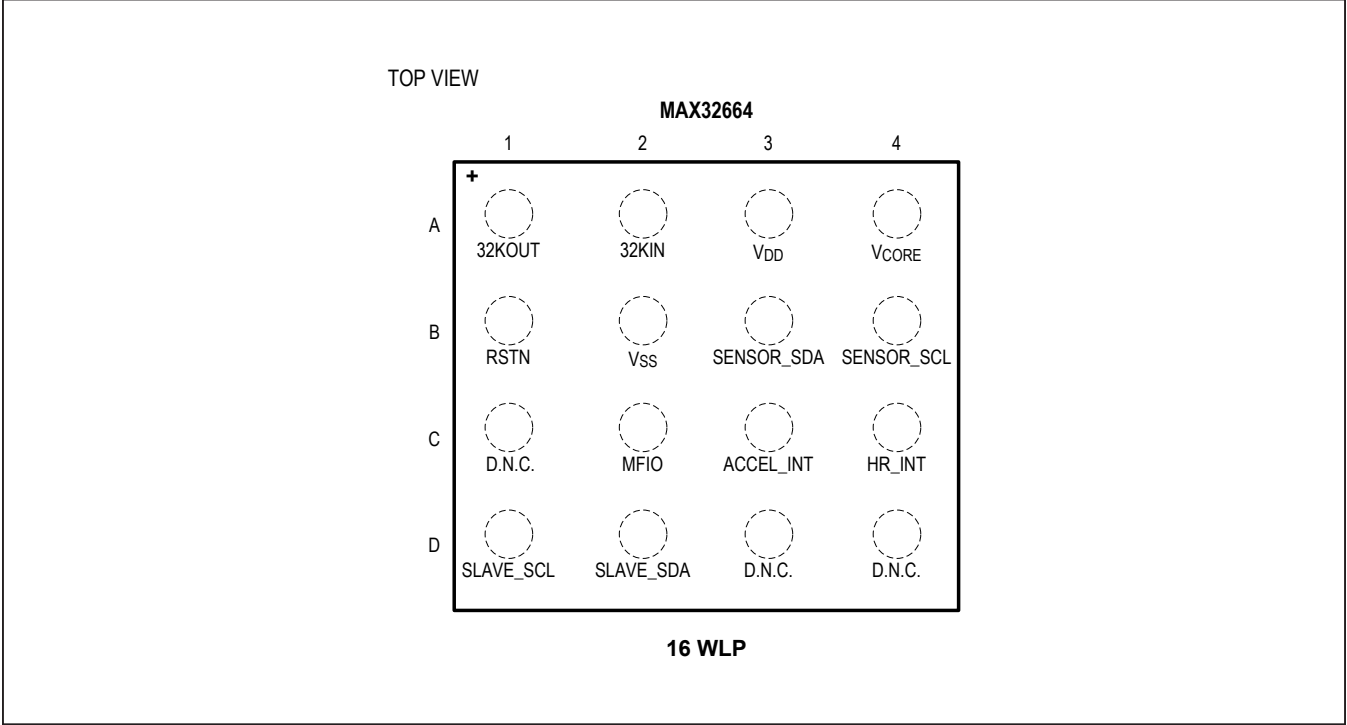


Figure 1. I²C Timing Diagram

Bump Configuration



Bump Description

BUMP	NAME	FUNCTION
POWER		
A3	V _{DD}	Digital Supply Voltage. This pin must be bypassed to V _{SS} with a 1.0μF capacitor as close as possible to the package. The device can operate solely from this one power supply pin.
A4	V _{CORE}	Core Supply Voltage. This pin must be left open-circuit. This pin must always be bypassed to V _{SS} with a 1.0μF capacitor as close as possible to the package.
B2	V _{SS}	Digital Ground
CLOCK		
A2	32KIN	32.768kHz Crystal Oscillator Input. Connect a 32.768kHz crystal between 32KIN and 32KOUT for RTC operation. Optionally, an external clock source can be driven on 32KIN if the 32KOUT pin is left unconnected.
A1	32KOUT	32.768kHz Crystal Oscillator Output
RESET		
B1	RSTN	Hardware Power Reset (Active-Low) Input. The device remains in reset while this pin is in its active state. When the pin transitions to its inactive state, the device performs a POR reset (resetting all logic on all supplies except for real-time clock circuitry) and begins execution. This pin is internally connected with an internal pullup to the V _{DD} supply as indicated in the Electrical Characteristics table. Add and place a noise snubber circuit as close as possible to the device, with component values shown in the Typical Application Circuit .

Pin Description (continued)

BUMP	NAME	FUNCTION
I²C		
D1	SLAVE_SCL	Slave SCL. This is the I ² C slave SCL that should be connected to the host microprocessor I ² C master SCL.
D2	SLAVE_SDA	Slave SDA. This is the I ² C slave SDA that should be connected to the host microprocessor I ² C master SDA.
B4	SENSOR_SCL	Sensor SCL. This is the I ² C master SCL that should be connected to the I ² C slave SCL on the slave sensors.
B3	SENSOR_SDA	Sensor SDA. This is the I ² C master SDA that should be connected to the I ² C slave SDA on the slave sensors.
INTERRUPTS		
C4	HR_INT	Heart Rate Monitor Interrupt Input. This pin connects to the heart rate monitor sensor interrupt output.
C3	ACCEL_INT	Accelerometer Interrupt Input. This pin connects to the accelerometer sensor interrupt output.
C2	MFIO	Multifunction IO. This pin provides different functions: MFIO asserts low as an output when the sensor hub needs to communicate with the host controller; the pin acts as an input and causes the sensor hub to enter bootloader mode if the MFIO pin is low during a reset.
DO NOT CONNECT		
C1, D3, D4	D.N.C.	Do Not Connect. Internally connected. Do not make any electrical connection, including V _{SS} , to these pins.

Detailed Description

The MAX32664 is a sensor hub family with embedded firmware and algorithms for wearables. It seamlessly enables customer-desired sensor functionality, including communication with Maxim's optical sensor solutions and delivering raw or calculated data to the outside world. This is achieved while keeping overall system power consumption in check.

The MAX32664 Version A supports the MAX30101/MAX30102 high-sensitivity pulse oximeter and heart-rate sensor for wearable health for finger-based applications.

The sensor hub interface provides an fast-mode I²C slave interface to transmit commands and data to a microcontroller host. A second I²C interface is dedicated to communication with sensors.

The sampling of the sensors is derived from the 32.768kHz real-time clock. The sampling rate is user-configurable to minimize power consumption.

Algorithmic Processing**Finger Heart Rate Algorithms**

The MAX32664 Version A performs finger-based heart rate and blood oxygen saturation (SpO₂) monitoring. The embedded algorithm uses digital filtering, pressure/position compensation, advanced R-wave detection, and automatic gain control to determine the heart rate in beats per minute while minimizing power. Also, the Maxim Integrated sensor hardware has built-in ambient light rejection to minimize background noise. SpO₂ results are reported as percentage of hemoglobin that is saturated with oxygen. The calibration values for SpO₂ configuration should be performed while using the end product.

I²C Interface

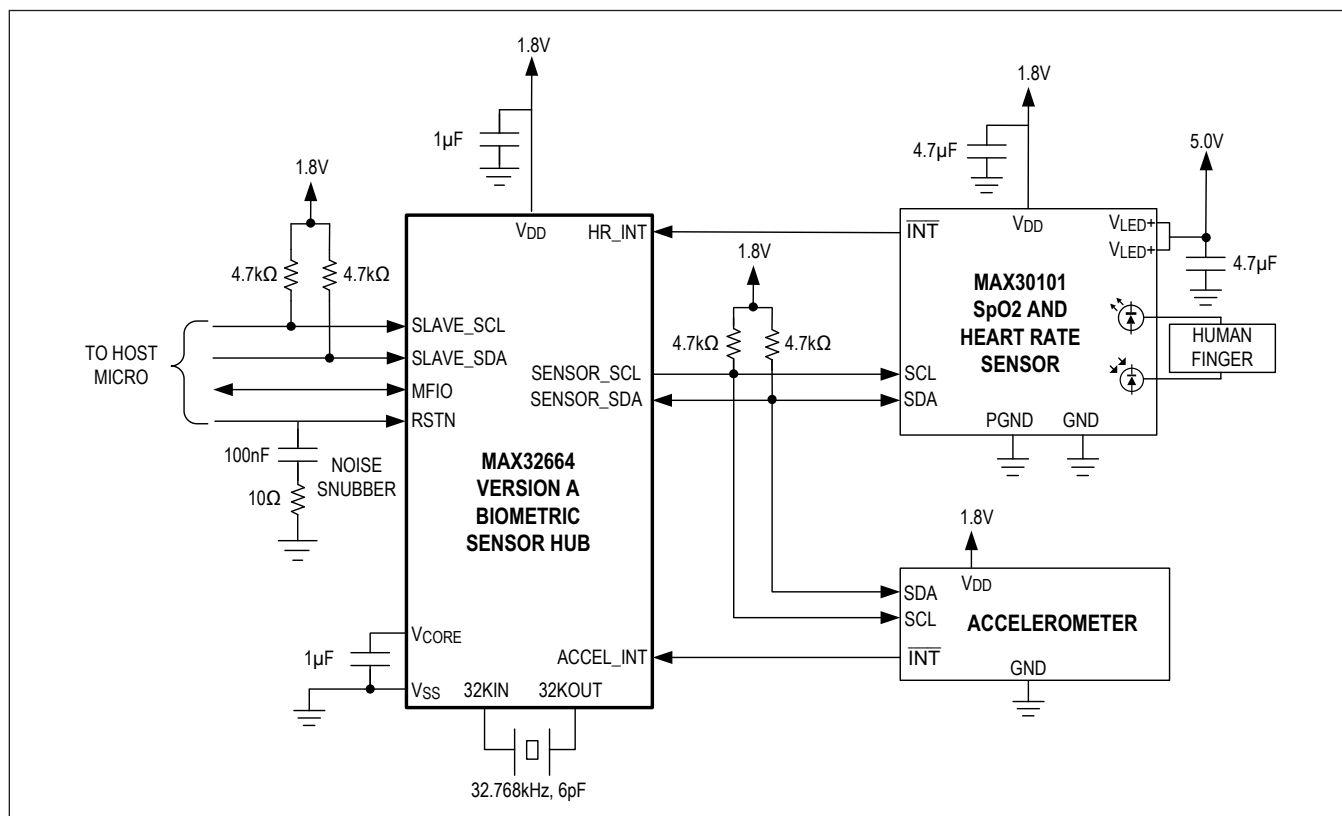
The I²C interface is a bidirectional, two-wire serial bus that provides a medium-speed communications network. The device provides two I²C busses.

The I²C sensor bus is dedicated to communication with the sensors. The characteristics of this bus are not user-configurable.

The I²C slave bus connects the sensor hub to a host system or microcontroller that acts as an I²C master. It provides the following features:

- Slave address 0x55
- Fast-mode (400kbps) transfer rate

- Supports standard 7-bit addressing or 10-bit addressing
- RESTART condition
- Interactive receive mode
- Tx FIFO preloading
- Support for clock stretching to allow slower slave devices to operate on higher speed busses
- Internal filter to reject noise spikes
- Receiver FIFO depth of 8 bytes
- Transmitter FIFO depth of 8 bytes

Typical Application Circuit

Ordering Information

PART	VERSION	BOOT LOADER	PIN-PACKAGE
MAX32664GWEA+	A	Yes	16 WLP (1.6mm x 1.6mm x 0.65mm, 0.35mm pitch)
MAX32664GWEA+T	A	Yes	16 WLP (1.6mm x 1.6mm x 0.65mm, 0.35mm pitch)
MAX32664GWEB+*	B	Yes	16 WLP (1.6mm x 1.6mm x 0.65mm, 0.35mm pitch)
MAX32664GWEB+T*	B	Yes	16 WLP (1.6mm x 1.6mm x 0.65mm, 0.35mm pitch)

+Denotes a lead(Pb)-free/RoHS-compliant package.

T = Tape and reel. Full reel.

*Future product—contact factory for availability.

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	4/18	Initial release	—
0.1		Added future product references to MAX32664GWEB+ and MAX32664GWEB+T	9

For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim Integrated's website at www.maximintegrated.com.

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